Electronic Acknowledgement Receipt					
EFS ID:	1046031				
Application Number:	10650193				
Confirmation Number:	6245				
Title of Invention:	Semiconductor device having silicon-diffused metal wiring layer and its manufacturing method				
First Named Inventor:	Koichi Ohto				
Customer Number:	23373				
Filer:	Howard Leonard Bernstein/Melissa Patrick				
Filer Authorized By:	Howard Leonard Bernstein				
Attorney Docket Number:	Q77191				
Receipt Date:	12-MAY-2006				
Filing Date:	28-AUG-2003				
Time Stamp:	14:46:15				
Application Type:	Utility				
International Application Number:					

## Payment information:

Submitted with Payment	no
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## File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1		Q77191Response.pdf	92765	yes	5

	Multipart Description			
	Doc Desc	Start	End	
	Amendment - After Non-Final Rejection	1	1	
	Applicant Arguments/Remarks Made in an Amendment	2	5	
Warnings:		<u>'</u>		

Information:

Total Files Size (in bytes): 92765

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## New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

## National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.